

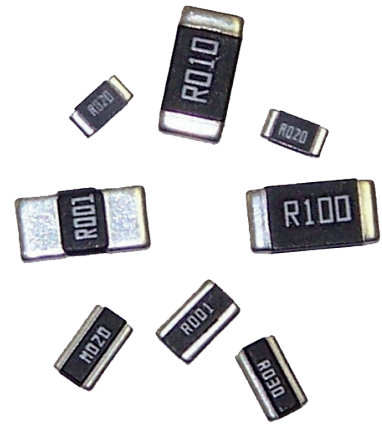
Low Resistance Metal Alloy Resistor



LRMA Series

Features

- Resistance range 0.5mΩ to 500mΩ
- High temperature operation to 170°C
- Low thermal EMF version
- High power version
- Current sensing for power electronics
- RoHS compliant & halogen free
- AEC-Q200 qualified



All parts are Pb-free and comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

Electrical Data

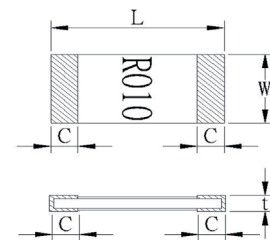
LRMA Version	T (Standard)		P (Power)
Size	2010	2512	2512
Power rating @70°C	W	1.5	≤R10: 3, >R10: 2
Overload rating (5s)	W	7.5	≤R10: 15, >R10: 10
Resistance range	mΩ	2 to 50	0.5 to 500
Standard values ¹	mΩ	2, 5, 6, 10, 15, 20, 50	1, 1.5, 2, 3, 3.5, 4, 5, 6, 7, 8, 10, 11, 12, 15, 18, 20, 25, 30, 33, 35, 40, 50, 100
Resistance tolerance	%	0.5 ¹ , 1, 5	
TCR (25 to 125°C)	ppm/°C	≥R01: ±75	>R001 & <R01: ±100, ≤R001: ±275
Ambient temperature	°C	-55 to 170	
Insulation resistance	MΩ	>100	
Element alloy	Cu-Ni		Cu-Ni / Mn-Cu

LRMA Version	M (Low thermal EMF)			N (Inverse)		
Size	0805	1206	2512	0612	0815	1225
Power rating @70°C	W	0.5	1	≤R01: 2, >R01: 1	1 ²	3
Overload rating (5s)	W	2.5	5	≤R01: 10, >R01: 5	5	15
Resistance range	mΩ	1 to 25	1 to 50	0.5 to 50	1 to 10	3 to 30
Standard values ¹	mΩ	1, 2, 3, 5, 6, 8, 9, 10, 20, 25	1, 1.2, 2, 3, 4, 5, 6, 7, 8, 9, 10, 12, 14, 15, 18, 20, 22, 25, 30, 39, 40, 50	0.5, 0.75, 1, 1.5, 2, 3.5, 5, 10, 20, 25, 30, 40, 50	1, 3, 5, 10	3, 4, 5, 10, 15, 20, 25, 30
Resistance tolerance	%	0.5 ¹ , 1, 5			±100	
TCR (25 to 125°C)	ppm/°C	±100	±50	≥R01: ±75, >R001 & <R01: ±100	≤R001: ±275	
Ambient temperature	°C	-55 to 170°C				
Insulation resistance	MΩ	>100				
Element alloy	Mn-Cu			Mn-Cu / Cu-Ni		

Notes: 1. Non-standard values and 0.5% tolerance may be available for high volume requirements. 2. Requires 300mm² copper pad & trace area

Physical Data (All dimensions in mm and nominal weight in mg)

Size	L	W	C	t	Wt
0805	2.0 ±0.1	1.25 ±0.1	0.4 ±0.2	0.6 ±0.2	5.5
0805 ≤R002			0.6 ±0.2		
1206 <R002	3.2 ±0.2	1.6 ±0.2	1.1 ±0.3	0.75 ±0.2	18.3
1206 ≥R002			0.5 ±0.3		
0612	1.7 ±0.2	3.2 ±0.2	0.4 ±0.2	0.6 ±0.2	12.9
0815	2.1 ±0.25	3.75 ±0.3	0.5 ±0.2	0.7 ±0.2	14.1
2010	5.0 ±0.2	2.5 ±0.2	0.6 ±0.3	0.6 ±0.2	35.6
2512 <R001	6.4 ±0.2	3.2 ±0.2	2.6 ±0.2	0.65 ±0.25	57 to 63
2512 ≥R001 & ≤R003 ¹			2.0 ±0.2		
2512 >R003 ¹			0.9 ±0.2		
1225	3.2 ±0.3	6.4 ±0.3	0.5 ±0.2	0.9 ±0.2	70



Note 1 - This applies to LRMAT2512 and LRMAM2512. For LRMAP2512 this threshold is R004

General Note

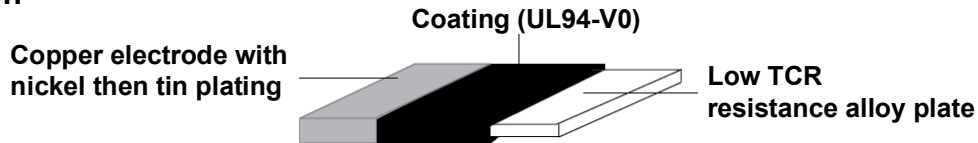
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BI Technologies IRC Welwyn

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LRMA Series

Construction



Marking

The components are marked with ohmic value, e.g. "R002" = 2mΩ, "R010" = 10 mΩ. Due to space restrictions, for LRMAM1206-R001, "01" = 1mΩ is used, and for LRMAM0805, "2" = 2mΩ, "010" = 10 mΩ are used.

Solvent Resistance

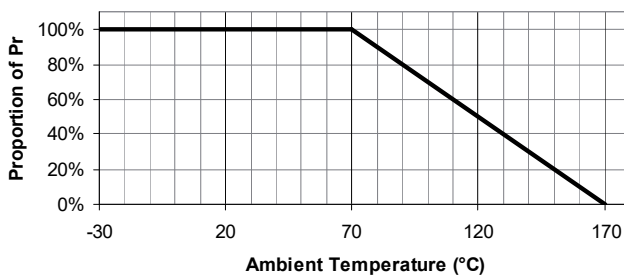
The component is resistant to all normal industrial cleaning solvents suitable for printed circuits.

Performance Data

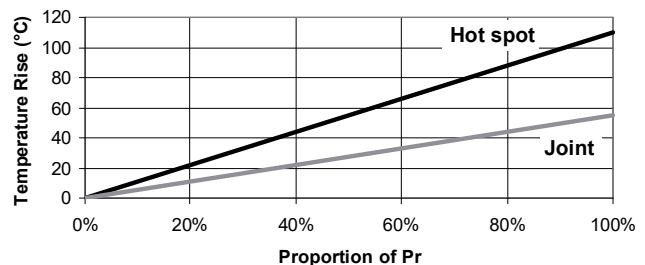
		Maximum (%)	Typical (%)
Load at rated power (cyclic load, 1000 hours at 70°C)	±ΔR	0805: 1.5 Others 1	0.3
Short term overload (5 x rated power for 5s)	±ΔR	0.5	0.15
Humidity (1000 hours, 85°C, 85%RH)	±ΔR	0805: 1 Others 0.5	0.15
Temperature cycle (-40 to +125°C, 1000 cycles, 15 minute dwell)	±ΔR	0805: 1 Others 0.5	0.15
Resistance to solder heat (260°C ±5°C for 20s ±1s)	±ΔR	0.5	0.3
Solderability (245°C ±5°C for 2s ±0.5s)		>95% coverage	
Dry heat (1000 hours at 170°C)	±ΔR	0805: 1.5 Others 0.5	0.3
Low temperature storage (1000 hours at -55°C)	±ΔR	0.5	0.15
Substrate bending (board 1.6mm, fulcrum spacing 90mm, deflection 2mm)	±ΔR	0805: 1 Others 0.5	0.3
Insulation resistance (1 minute @ 100Vdc)		>100M	
Sulphur Resistance (ASTM B-809-95 (modified) 105°C dry, 1000 hours. Visual inspection x10)		Pass	

Thermal Performance & Mounting

Temperature Derating

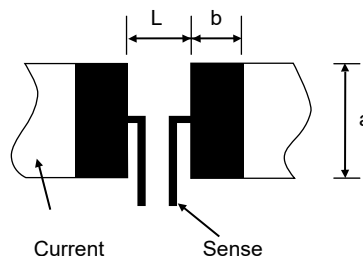


Typical Temperature Rise



Reference Pad Dimensions (mm)

Size	a	b	L
0612	3.8	0.7	0.7
0805	1.4	1.15	1.2
1206 <R002	1.8	2.3	1.0
1206 ≥R002	1.8	1.7	1.6
0815	7.9	1.5	0.9
2010	3.4	1.5	3.5
2512 ≤R003 ¹	4.0	3.1	1.3
2512 >R003 ¹	4.0	2.1	4.1
1225	7.0	1.0	2.3



The temperature rise shown is highly dependent on mounting conditions. Reference conditions assume 20μ copper with thermal vias to multiple layers. The self-heating in the current tracks should be kept negligible, or allowed for by temperature derating.

Note 1 - This applies to LRMAT2512 and LRMAM2512. For LRMAP2512 this threshold is R004

Standard 4-terminal probe pitches for measuring unmounted parts are 2.8 x 1.7mm (0612), 0.4 x 1.83mm (0805), 0.4 x 2.8mm (1206), 1.2 x 4.5mm (2010), 1.5 x 5.8mm (2512), and 5.4 x 3.4mm (1225). All probe location tolerances ±0.02mm.

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LRMA Series

Packaging

Size	Tape	A	B	W	F	E	P ₁	P ₂	P ₀	ΦD ₀	t	ΦA	ΦB	ΦC	Wr	Tr
0805	Paper	1.6 ±0.15	2.4 ±0.2	8.0 ±0.2	3.5 ±0.05	1.75 ±0.1	4.0 ±0.1	2.0 ±0.1	4.0 ±0.1	1.5 +0.1/-0	0.84 ±0.1	178 ±2	60 ±1	13 ±1	9 ±1	11.4 ±1
0612, 1206	Paper	2.0 ±0.15	3.6 ±0.2	8.0 ±0.2	3.5 ±0.05	1.75 ±0.1	4.0 ±0.1	2.0 ±0.05	4.0 ±0.1	1.5 +0.1/-0	0.84 ±0.1	178 ±2	60 ±1	13 ±1	9 ±1	11.5 ±1
0815	Emboss	2.6 ±0.2	4.5 ±0.2	12 ±0.2	5.5 ±0.1	1.75 ±0.1	4.0 ±0.1	2.0 ±0.2	4.0 ±0.1	1.55 ±0.05	1.1 ±0.1	178 ±2	60 ±1	13 ±1	13 ±1	15.4 ±2
2010	Emboss	2.8 ±0.2	5.3 ±0.2	12 ±0.05	5.5 ±0.05	1.75 ±0.1	4.0 ±0.1	2.0 ±0.05	4.0 ±0.05	1.5 +0.1/-0	0.85 ±0.15	178 ±2	60 ±1	13 ±1	13 ±1	15.4 ±2
2512 1225	Emboss	3.6 ±0.2	6.9 ±0.2	12 ±0.2	5.5 ±0.05	1.75 ±0.1	4.0 ±0.1	2.0 ±0.05	4.0 ±0.05	1.5 +0.1/-0	0.85 ±0.15	178 ±2	60 ±1	13 ±1	13 ±1	15.4 ±2

Storage

Conditions: 5°C to 35°C and 40% to 75%RH

Shelf life: 2 years from manufacture

Processing

LRMA series resistors are suitable for both wave and IR reflow soldering. The recommended reflow profile for Pb-free SAC305 alloy (Sn 96.5%, Ag 3%, Cu 0.5%) soldering is as follows:

Pre-heat: 60s to 120s at 150°C to 180°C

Soldering: 20s to 40s at ≥230°C

Peak: 5s at 255°C to 260°C

Ordering Procedure

Example: LRMAM2512-R01FT4 (LRMA2512, low thermal EMF, 10 milliohms ±1%, Pb-free)



1	2	3	4	5	6			
Type	Version	Size	Value	Tolerance	Packing			
LRMA	T	Standard	0612	3 to 6 characters	D = ±0.5%	Tape & reel		
	P	Power			0805	F = ±1%	T5	0612, 0805, 1206
	M	Low thermal EMF	1206	R = ohms	J = ±5%	T4	0815, 2010, 2512, 1225	4000/reel
	N	Inverse	0815					
		2010						
		2512						
		1225						

Note 1: For values which require all 6 characters, e.g. R00075, the hyphen is omitted.

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